

672-Pin Ultra FineLine Ball-Grid Array (UBGA) - Wire Bond - A:1.85

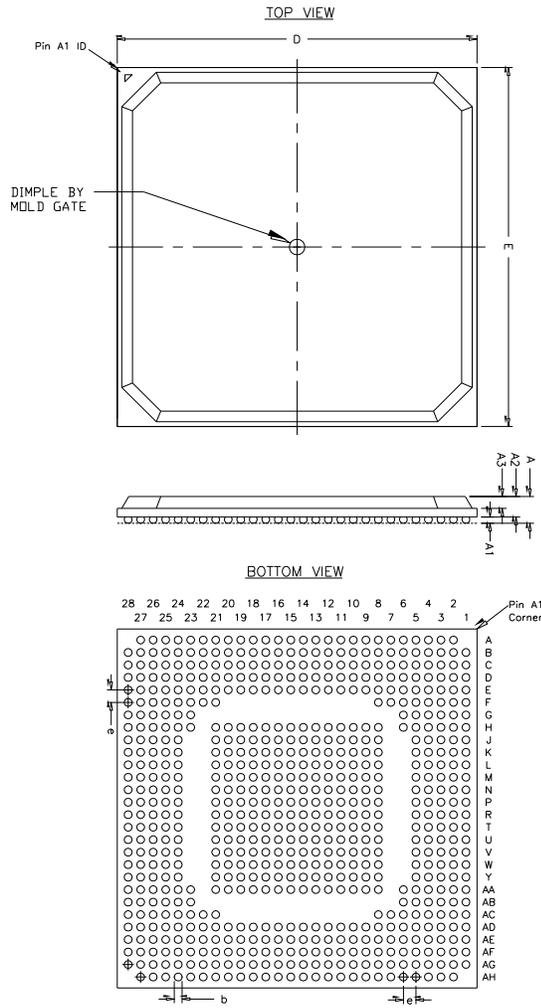
- All dimensions and tolerances conform to ASME Y14.5M – 1994.
- Controlling dimension is in millimeters.
- Pin A1 may be indicated by an ID dot, or a special feature, in its proximity on package surface.

Package Information	
Description	Specification
Ordering Code Reference	U
Package Acronym	UBGA
Substrate Material	BT
Solder ball composition	Regular: 63Sn:37Pb (Typ.) Pb-free: Sn:3Ag:0.5Cu (Typ.)
JEDEC Outline Reference	MO-216 Variation: BAU-1
Lead Coplanarity	0.005 inch (0.12 mm)
Weight	2.2 g (Typ.)
Moisture Sensitivity Level	Printed on moisture barrier bag

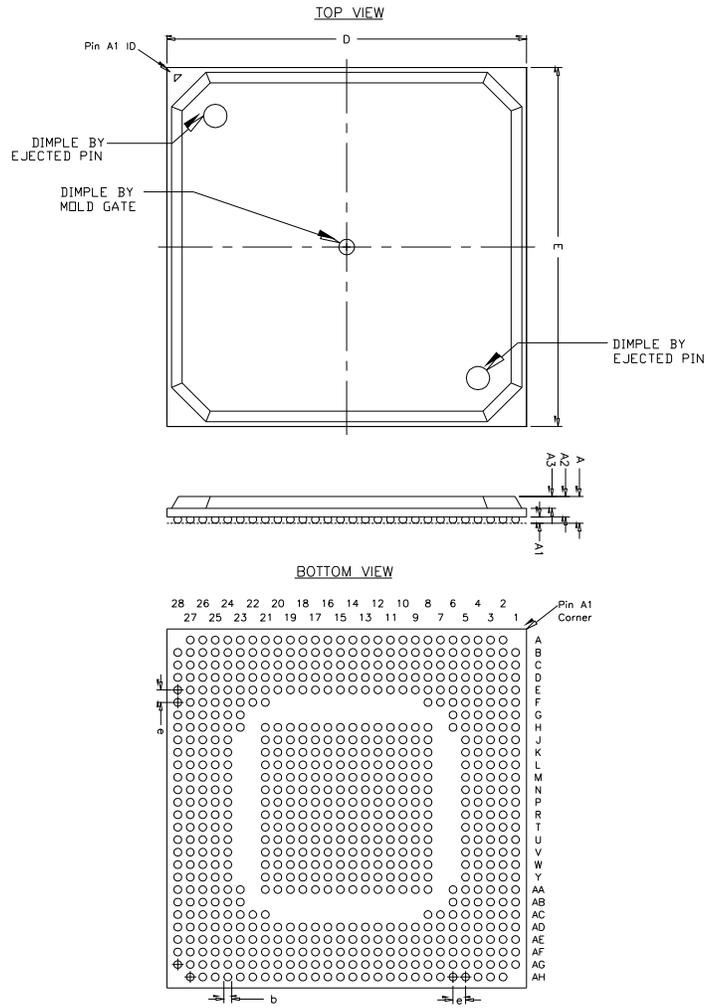
Package Outline Dimension Table			
Symbol	Millimeters		
	Min.	Nom.	Max.
A	1.55	1.70	1.85
A1	0.35	0.40	0.45
A2	1.10	1.30	1.50
A3	0.71	0.76	0.81
D	23.00 BSC		
E	23.00 BSC		
b	0.45	0.50	0.55
e	0.80 BSC		

Package Outline

OPTION 1



OPTION 2



Document Revision History

Table 1 shows the revision history for this document.

Table 1. Document Revision History

Date	Version	Changes
October 2011	1.0	Initial release
December 2012	2.0	Add option 2 package outline in page.2.



101 Innovation Drive
San Jose, CA 95134
www.altera.com

© 2012 Altera Corporation. All rights reserved. ALTERA, ARRIA, CYCLONE, HARDCOPY, MAX, MEGACORE, NIOS, QUARTUS and STRATIX are Reg. U.S. Pat. & Tm. Off. and/or trademarks of Altera Corporation in the U.S. and other countries. All other trademarks and service marks are the property of their respective holders as described at www.altera.com/common/legal.html. Altera warrants performance of its semiconductor products to current specifications in accordance with Altera's standard warranty, but reserves the right to make changes to any products and services at any time without notice. Altera assumes no responsibility or liability arising out of the application or use of any information, product, or service described herein except as expressly agreed to in writing by Altera. Altera customers are advised to obtain the latest version of device specifications before relying on any published information and before placing orders for products or services.